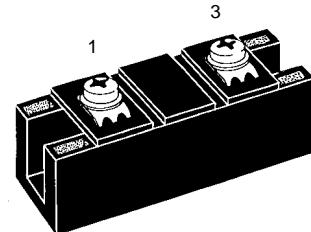
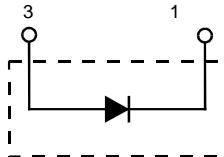


Fast Recovery Epitaxial Diode (FRED) Module

MEO 550-02 DA

V_{RRM} = 200 V
I_{FAVM} = 582 A
t_{rr} = 150 ns

V _{RSM}	V _{RRM}	Type
V	V	
200	200	MEO 550-02DA

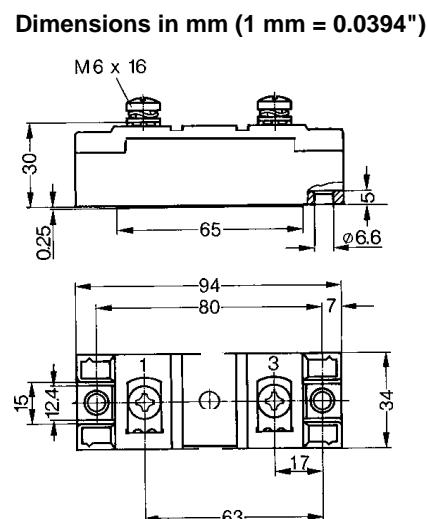


Symbol	Test Conditions	Maximum Ratings	
I _{FRMS}	T _c = 75°C	822	A
I _{FAVM} ①	T _c = 75°C; rectangular, d = 0.5	582	A
I _{FRM}	t _p < 10 µs; rep. rating, pulse width limited by T _{VJM}	2880	A
I _{FSM}	T _{VJ} = 45°C; t = 10 ms (50 Hz), sine	4800	A
	t = 8.3 ms (60 Hz), sine	5280	A
	T _{VJ} = 150°C; t = 10 ms (50 Hz), sine	4320	A
	t = 8.3 ms (60 Hz), sine	4750	A
I ² t	T _{VJ} = 45°C; t = 10 ms (50 Hz), sine	115200	A ² s
	t = 8.3 ms (60 Hz), sine	117100	A ² s
	T _{VJ} = 150°C; t = 10 ms (50 Hz), sine	93300	A ² s
	t = 8.3 ms (60 Hz), sine	94800	A ² s
T _{VJ}		-40...+150	°C
T _{stg}		-40...+125	°C
T _{Smax}		110	°C
P _{tot}	T _c = 25°C	1750	W
V _{ISOL}	50/60 Hz, RMS t = 1 min	3000	V~
	I _{ISOL} ≤ 1 mA t = 1 s	3600	V~
M _d	Mounting torque (M6)	2.25-2.75/20-25	Nm/lb.in.
	Terminal connection torque (M6)	4.50-5.50/40-48	Nm/lb.in.
d _s	Creep distance on surface	12.7	mm
d _a	Strike distance through air	9.6	mm
a	Maximum allowable acceleration	50	m/s ²
Weight		150	g

Symbol	Test Conditions	Characteristic Values (per diode)	
		typ.	max.
I _R	T _{VJ} = 25°C V _R = V _{RRM}	5	mA
	T _{VJ} = 25°C V _R = 0.8 • V _{RRM}	4	mA
	T _{VJ} = 125°C V _R = 0.8 • V _{RRM}	160	mA
V _F	I _F = 300 A; T _{VJ} = 125°C	0.84	V
	T _{VJ} = 25°C	1.10	V
	I _F = 520 A; T _{VJ} = 125°C	1.08	V
	T _{VJ} = 25°C	1.25	V
V _{To}	For power-loss calculations only	0.52	V
r _T		1.06	mΩ
R _{thJH}	DC current	0.114	K/W
R _{thJC}	DC current	0.071	K/W
t _{rr} I _{RM}	I _F = 500 A V _R = 100 V -di/dt = 200 A/µs	150	ns
	{ T _{VJ} = 100°C T _{VJ} = 25°C T _{VJ} = 100°C	200 9 15	A A A

① I_{FAVM} rating includes reverse blocking losses at T_{VJM}, V_R = 0.6 V_{RRM}, duty cycle d = 0.5
Data according to IEC 60747

IXYS reserves the right to change limits, test conditions and dimensions



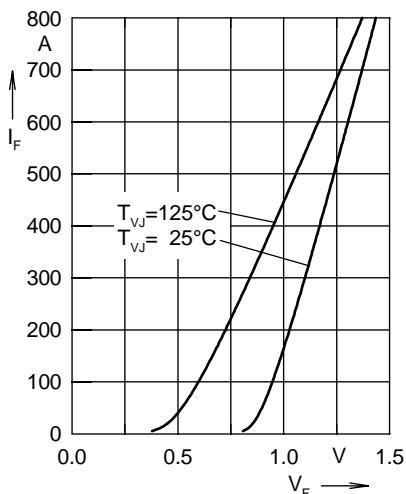


Fig. 1 Forward current I_F versus max. voltage drop V_F per leg

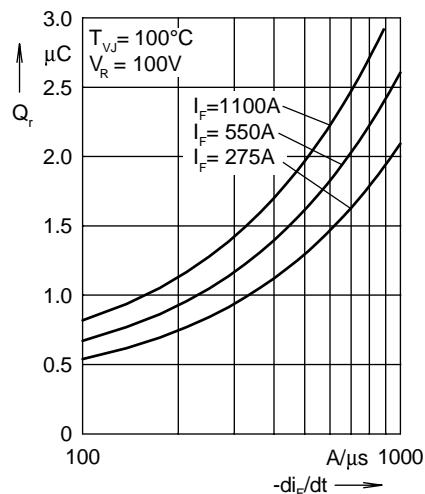


Fig. 2 Typ. reverse recovery charge Q_r versus $-di_F/dt$

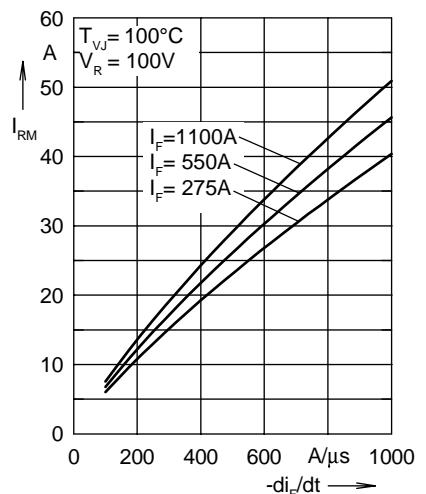


Fig. 3 Typ. peak reverse current I_{RM} versus $-di_F/dt$

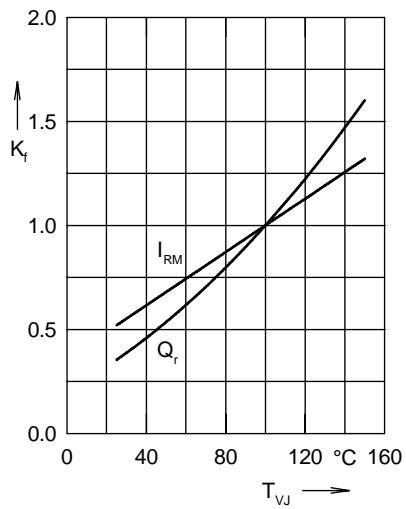


Fig. 4 Dynamic parameters Q_r , I_{RM} versus junction temperature T_{VJ}

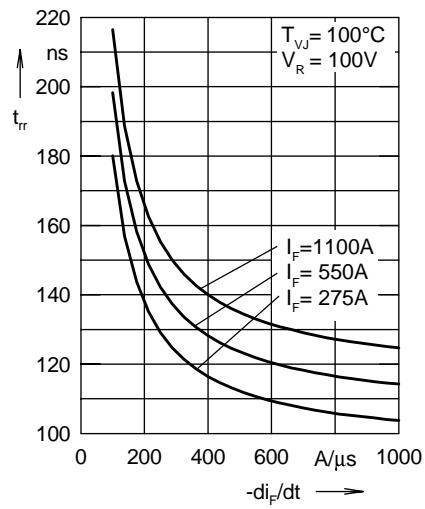


Fig. 5 Typ. recovery time t_{rr} versus $-di_F/dt$

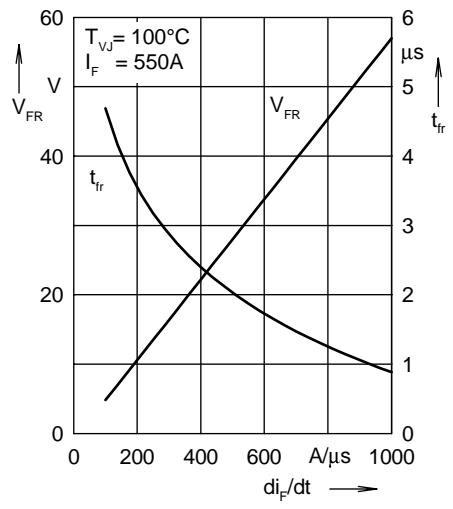


Fig. 6 Typ. peak forward voltage V_{FR} and t_{rr} versus di_F/dt

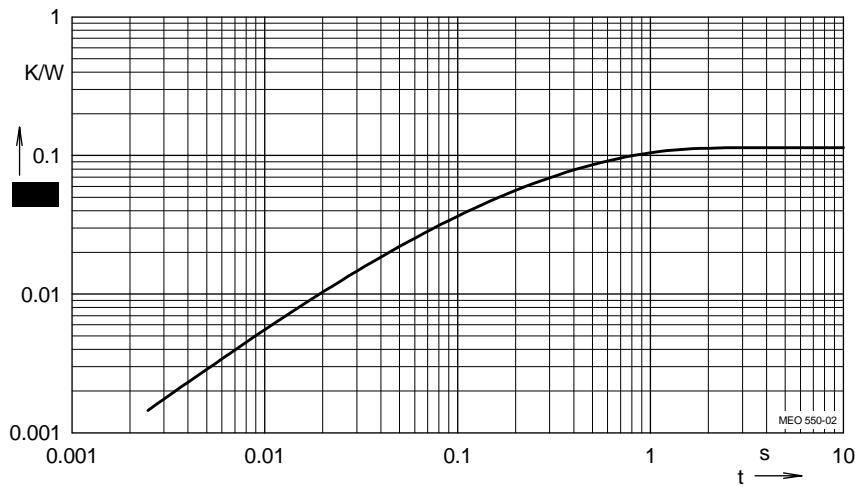


Fig. 7 Transient thermal impedance junction to heatsink

Constants for Z_{thJS} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.001	0.08
2	0.004	0.024
3	0.027	0.112
4	0.082	0.464